

Imaging and Depth Profiling of SiC-MOSFET by NanoSIMS 50L

3D imaging of SiC-MOSFET was obtained by NanoSIMS 50L, which is a secondary ion mass spectrometer with high lateral resolution and sensitivity. Depth profile of ROI (region of interest) extracted from the 3D image shows a large dynamic range of n-type dopant of phosphorus.

NanoSIMS 50L

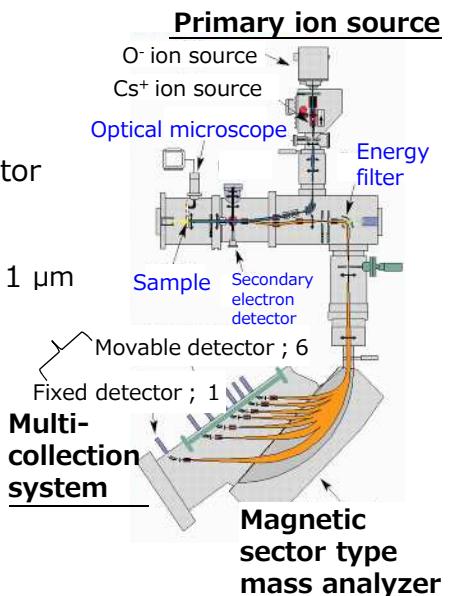
Imaging & Depth Profile

- High lateral resolution
- High sensitivity
- Isotope analysis

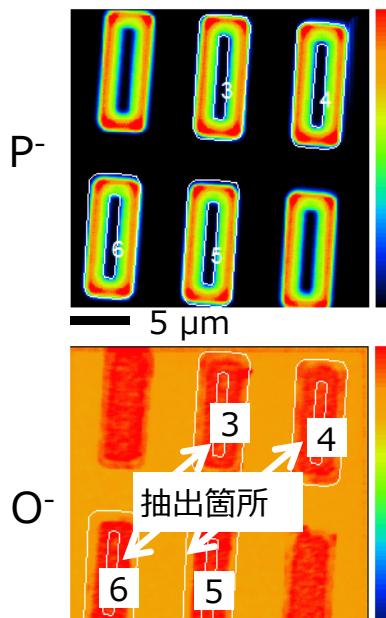


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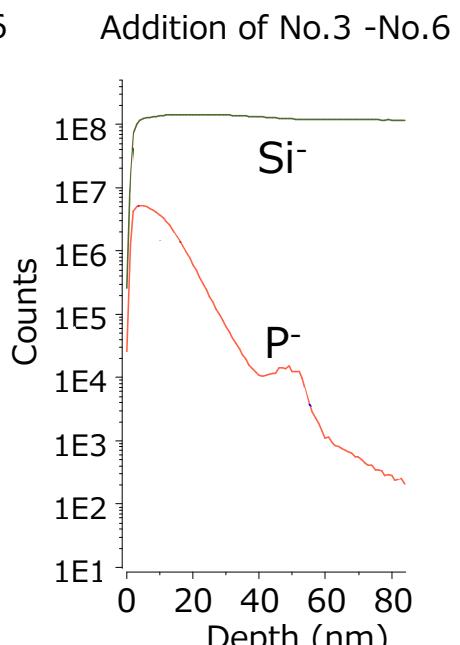
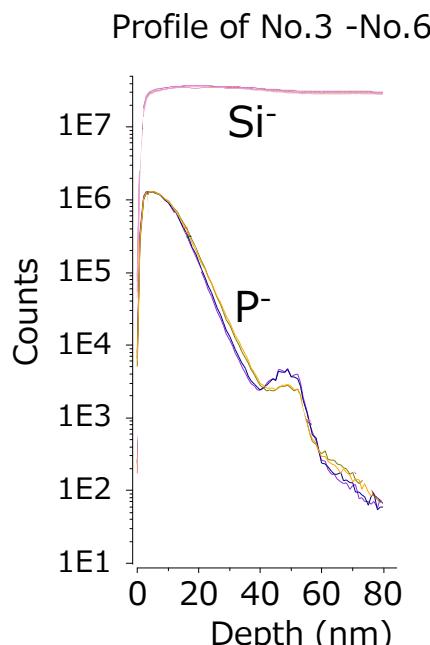
- Primary ion : Cs⁺, O⁻
- Beam size : 50 nm
- Detection limit : ppb – ppm
- Mass analyzer : Magnetic Sector
- Number of ion detected simultaneously : 7
- Depth capability : 数10 nm – 1 μm



Imaging and Depth Profiling of SiC-MOSFET*



Imaging at 2-3 nm depth



- Depth profile of ROI (region of interest) from 3D data
- Large dynamic range of Phosphorus

*Silicon Carbide Metal-oxide-semiconductor Field Effect Transistor